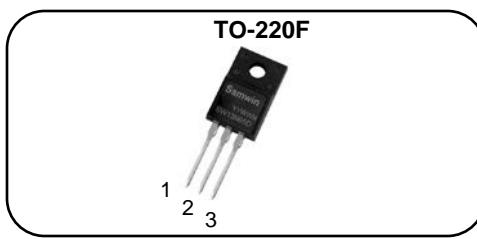


### Features

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 0.6Ω)@ $V_{GS}=10V$
- Low Gate Charge (Typ 54nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: LED, Charger, PC Power

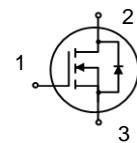
### N-channel Enhanced mode TO-220F MOSFET



$BV_{DSS}$  : 650V

$I_D$  : 13A

$R_{DS(ON)}$  : 0.6Ω



### General Description

This power MOSFET is produced with advanced technology of SAMWIN.

This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

### Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW F 13N65D	SW13N65D	TO-220F	TUBE

### Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain to source voltage	650	V
$I_D$	Continuous drain current (@ $T_C=25^\circ C$ )	13*	A
	Continuous drain current (@ $T_C=100^\circ C$ )	8.2*	A
$I_{DM}$	Drain current pulsed (note 1)	52	A
$V_{GS}$	Gate to source voltage	$\pm 30$	V
$E_{AS}$	Single pulsed avalanche energy (note 2)	484	mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	45	mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5	V/ns
$P_D$	Total power dissipation (@ $T_C=25^\circ C$ )	28.4	W
	Derating factor above 25°C	0.23	W/ $^\circ C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150	$^\circ C$
$T_L$	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.	300	$^\circ C$

\*. Drain current is limited by junction temperature.

### Thermal characteristics

Symbol	Parameter	Value	Unit
$R_{thjc}$	Thermal resistance, Junction to case	4.4	$^\circ C/W$
$R_{thja}$	Thermal resistance, Junction to ambient	58	$^\circ C/W$

Electrical characteristic ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain to source breakdown voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	650			V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu\text{A}$ , referenced to $25^\circ\text{C}$		0.55		$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain to source leakage current	$V_{\text{DS}}=650\text{V}$ , $V_{\text{GS}}=0\text{V}$		1		$\mu\text{A}$
		$V_{\text{DS}}=520\text{V}$ , $T_C=125^\circ\text{C}$		50		$\mu\text{A}$
$I_{\text{GSS}}$	Gate to source leakage current, forward	$V_{\text{GS}}=30\text{V}$ , $V_{\text{DS}}=0\text{V}$		100		nA
	Gate to source leakage current, reverse	$V_{\text{GS}}=-30\text{V}$ , $V_{\text{DS}}=0\text{V}$		-100		nA
<b>On characteristics</b>						
$V_{\text{GS(TH)}}$	Gate threshold voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$	2.5		4.5	V
$R_{\text{DS(ON)}}$	Drain to source on state resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=6.5\text{A}$ , $T_j=25^\circ\text{C}$		0.6	0.75	$\Omega$
		$V_{\text{GS}}=10\text{V}$ , $I_D=6.5\text{A}$ , $T_j=125^\circ\text{C}$		1.2		$\Omega$
$G_{\text{fs}}$	Forward transconductance	$V_{\text{DS}}=30\text{V}$ , $I_D=6.5\text{A}$		12		S
<b>Dynamic characteristics</b>						
$C_{\text{iss}}$	Input capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=25\text{V}$ , $f=1\text{MHz}$		2074		pF
$C_{\text{oss}}$	Output capacitance			182		
$C_{\text{rss}}$	Reverse transfer capacitance			20		
$t_{\text{d(on)}}$	Turn on delay time	$V_{\text{DS}}=325\text{V}$ , $I_D=13\text{A}$ , $R_G=10\Omega$ , $V_{\text{GS}}=10\text{V}$ (note 4,5)		20		ns
$t_r$	Rising time			35		
$t_{\text{d(off)}}$	Turn off delay time			67		
$t_f$	Fall time			34		
$Q_g$	Total gate charge	$V_{\text{DS}}=520\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=13\text{A}$ , $I_g=5\text{mA}$ (note 4,5)		54		nC
$Q_{\text{gs}}$	Gate-source charge			11		
$Q_{\text{gd}}$	Gate-drain charge			23		
$R_g$	Gate resistance	$V_{\text{DS}}=0\text{V}$ , Scan F mode		1.8		$\Omega$

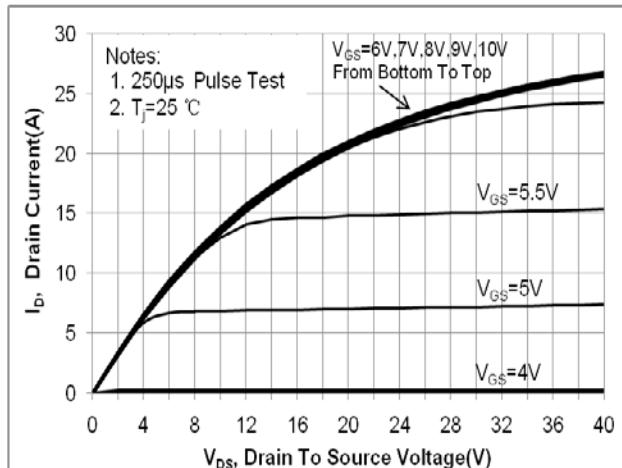
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			13	A
$I_{\text{SM}}$	Pulsed source current				52	A
$V_{\text{SD}}$	Diode forward voltage drop.	$I_s=13\text{A}$ , $V_{\text{GS}}=0\text{V}$			1.4	V
$t_{\text{rr}}$	Reverse recovery time	$I_s=13\text{A}$ , $V_{\text{GS}}=0\text{V}$ , $dI_F/dt=100\text{A/us}$		545		ns
$Q_{\text{rr}}$	Reverse recovery charge			5.3		$\mu\text{C}$

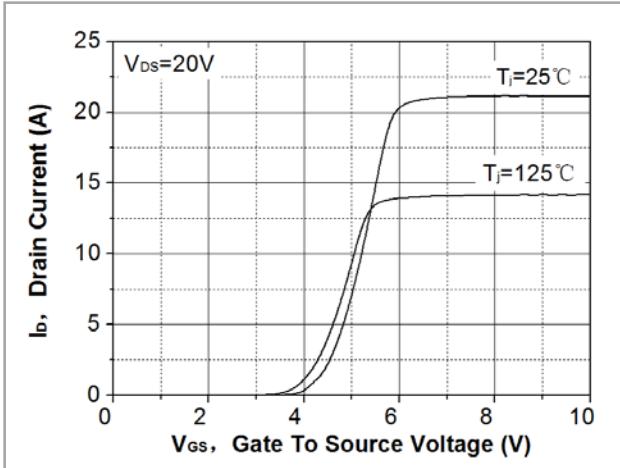
※. Notes

- Repetitive rating : pulse width limited by junction temperature.
- $L=8\text{mH}$ ,  $I_{as}=11\text{A}$ ,  $V_{DD}=100\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_j=25^\circ\text{C}$
- $I_{SD} \leq 13\text{A}$ ,  $di/dt = 100\text{A/us}$ ,  $V_{DD} \leq \text{BV}_{\text{DSS}}$ , Starting  $T_j=25^\circ\text{C}$
- Pulse Test : Pulse Width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.

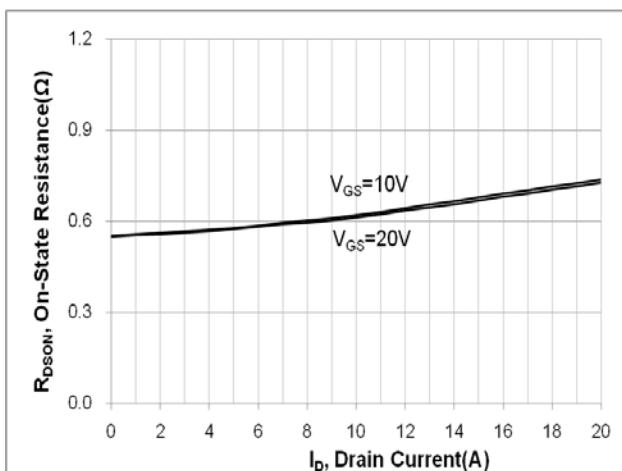
**Fig. 1. On-state characteristics**



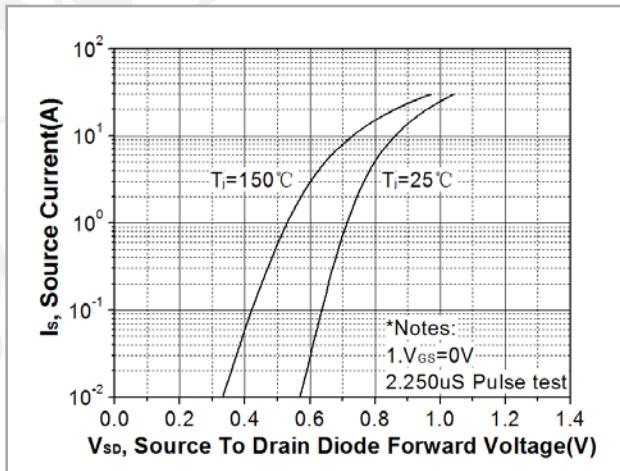
**Fig. 2. Transfer Characteristics**



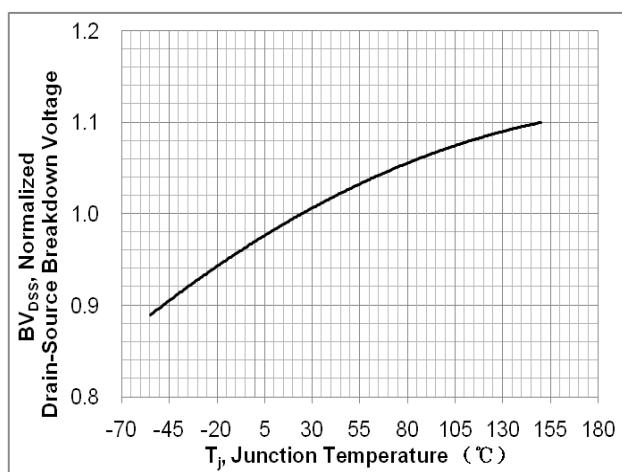
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



**Fig. 4. On-state current vs. diode forward voltage**



**Fig 5. Breakdown voltage variation vs. junction temperature**



**Fig. 6. On-resistance variation vs. junction temperature**

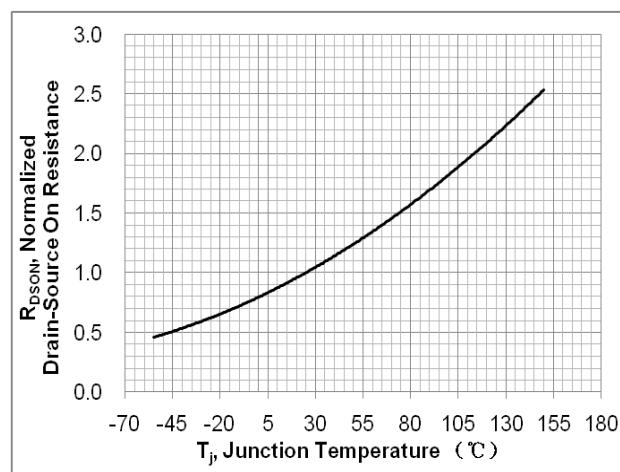


Fig. 7. Gate charge characteristics

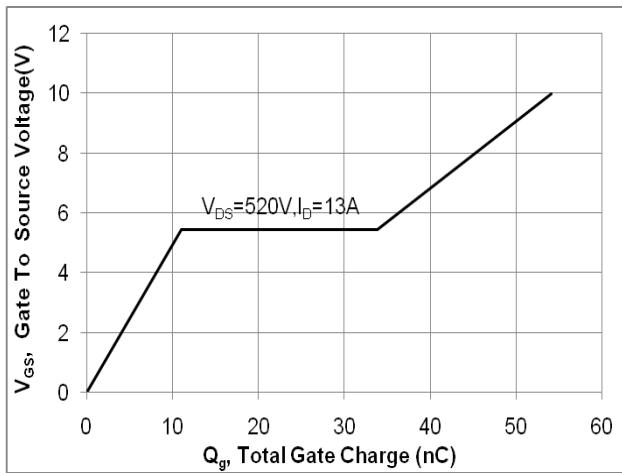


Fig. 8. Capacitance Characteristics

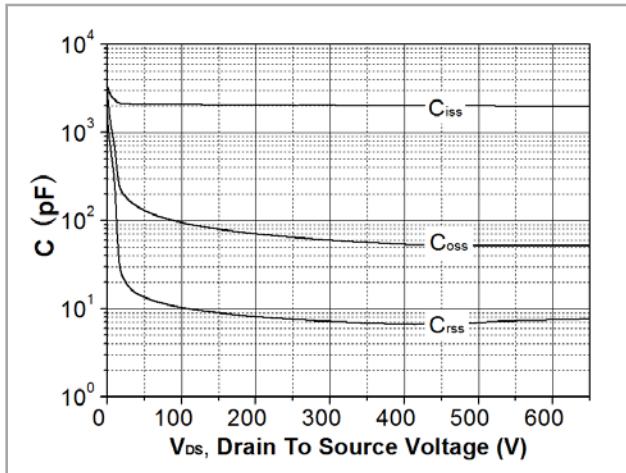


Fig. 9. Maximum safe operating area

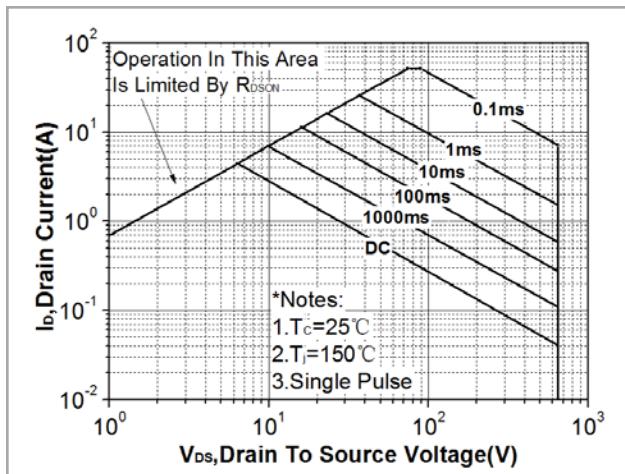


Fig. 10. Transient thermal response curve

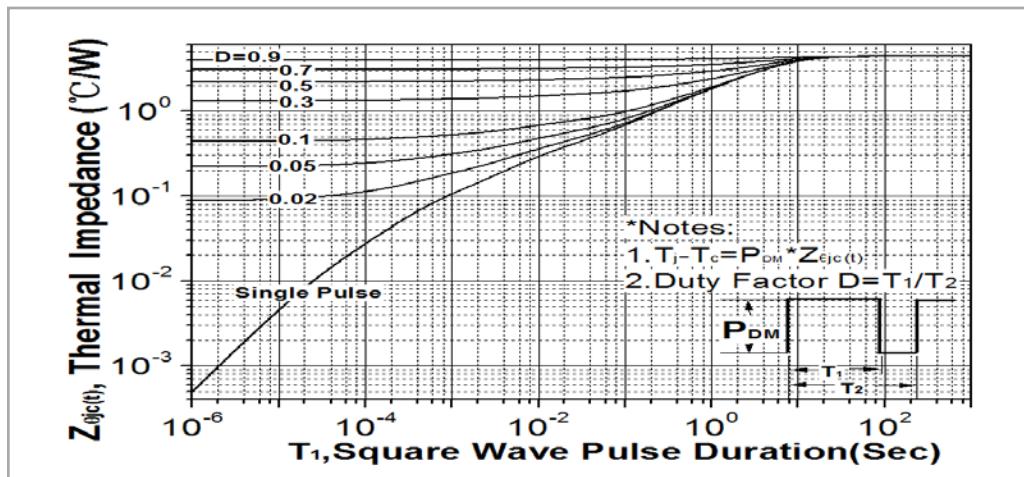


Fig. 11. Gate charge test circuit & waveform

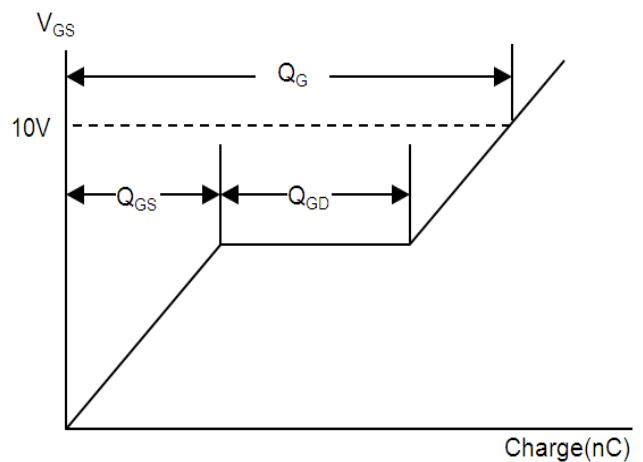
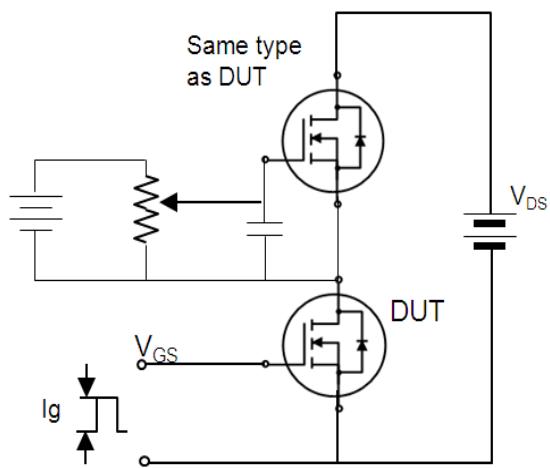


Fig. 12. Switching time test circuit & waveform

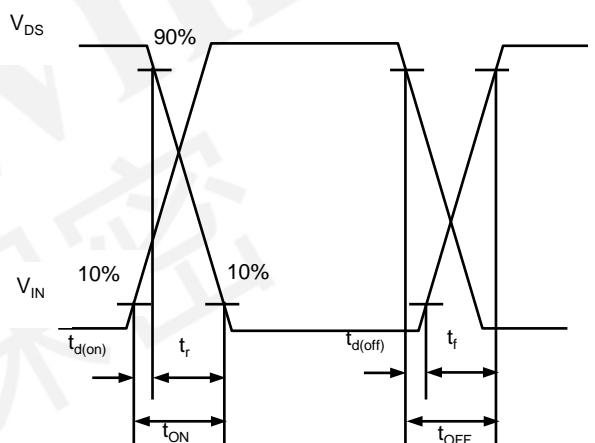
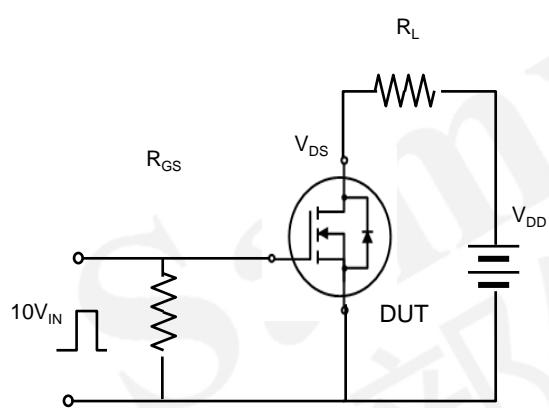


Fig. 13. Unclamped Inductive switching test circuit & waveform

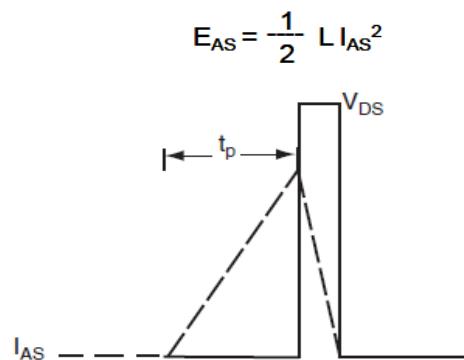
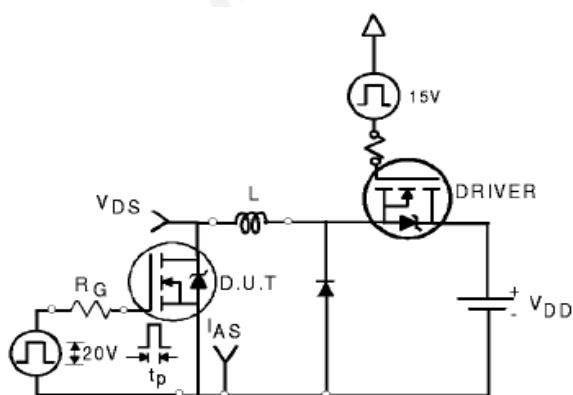
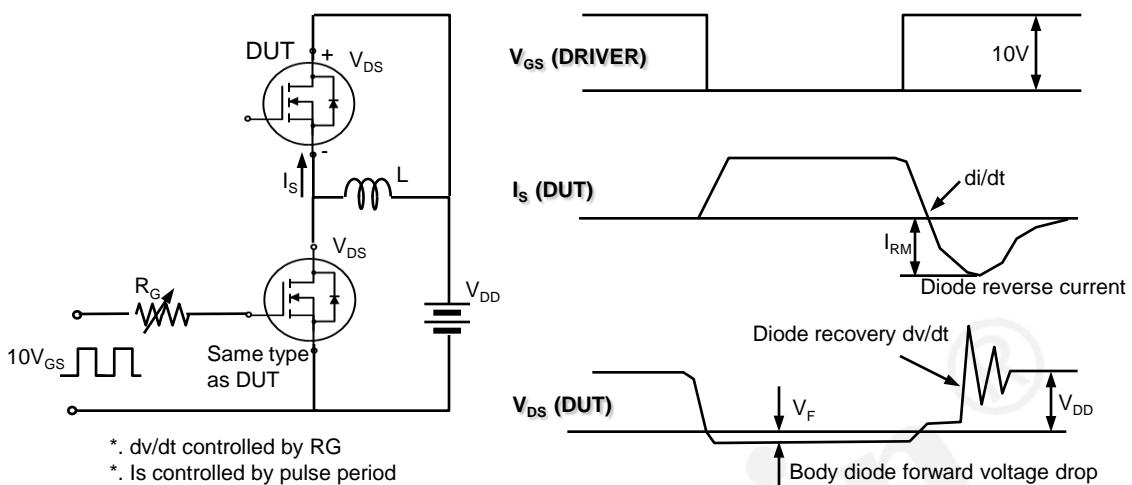


Fig. 14. Peak diode recovery dv/dt test circuit & waveform



### DISCLAIMER

- \* All the data & curve in this document was tested in XI'AN SEMIPOWER TESTING & APPLICATION CENTER.
- \* This product has passed the PCT, TC, HTRB, HTGB, HAST, PC and Solderdunk reliability testing.
- \* Qualification standards can also be found on the Web site (<http://www.semipower.com.cn>)
- \* Suggestions for improvement are appreciated, Please send your suggestions to [samwin@samwinse.com](mailto:samwin@samwinse.com)